

RELIABILITY REPORT
FOR
MAX4491AUA+

PLASTIC ENCAPSULATED DEVICES

December 22, 2009

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR. SUNNYVALE, CA 94086

Approved by
Ken Wendel
Quality Assurance
Director, Reliability Engineering



Conclusion

The MAX4491AUA+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim"s continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim"s quality and reliability standards.

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I. Device Description

A. General

The MAX4490/MAX4491 input and output capability from either a single +2.7V to +5.5V supply or dual ±1.35V to ±2.75V supplies. These amplifiers exhibit a high slew rate of 10V/µs and a gain-bandwidth product of 10MHz. They can drive 2k resistive loads to within 55mV of either supply rail and remain unity-gain stable with capacitive loads up to 300pF. The MAX4490 is offered in the ultra-small, 5-pin SC70 package, which is 50% smaller than the standard 5-pin SOT23 package. Specifications for all parts are guaranteed over the automotive (-40°C to +125°C) temperature range.



II. Manufacturing Information

A. Description/Function: Low-Cost, High-Slew-Rate, Rail-to-Rail I/O Op Amps in SC70

Level 1

B. Process: TS50

C. Number of Device Transistors:

D. Fabrication Location: Taiwan

E. Assembly Location: Malaysia, Philippines, Thailand

F. Date of Initial Production: January 22, 2000

III. Packaging Information

A. Package Type: 8-pin uMAX
B. Lead Frame: Copper

C. Lead Finish: 100% matte TinD. Die Attach: ConductiveE. Bondwire: Au (1 mil dia.)

F. Mold Material: Epoxy with silica filler
 G. Assembly Diagram: #05-2501-0100
 H. Flammability Rating: Class UL94-V0

Classification of Moisture Sensitivity per

JEDEC standard J-STD-020-C

J. Single Layer Theta Ja: 221°C/W
K. Single Layer Theta Jc: 41.9°C/W
L. Multi Layer Theta Ja: 206.3°C/W
M. Multi Layer Theta Jc: 41.9°C/W

IV. Die Information

A. Dimensions: 46 X 30 mils

B. Passivation: Si₃N₄/SiO₂ (Silicon nitride/ Silicon dioxide)

C. Interconnect: Al/0.5%Cu with Ti/TiN Barrier

D. Backside Metallization: None
E. Minimum Metal Width: 0.50μm
F. Minimum Metal Spacing: 0.50μm
G. Bondpad Dimensions: 5 mil. Sq.
H. Isolation Dielectric: SiO₂
I. Die Separation Method: Wafer Saw



V. Quality Assurance Information

A. Quality Assurance Contacts: Ken Wendel (Director, Reliability Engineering)

Bryan Preeshl (Managing Director of QA)

B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.

0.1% For all Visual Defects.

C. Observed Outgoing Defect Rate: < 50 ppmD. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (3) is calculated as follows:

$$\lambda = \frac{1}{\text{MTTF}} = \frac{1.83}{192 \times 4340 \times 80 \times 2}$$
 (Chi square value for MTTF upper limit)
where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)

$$\lambda = 13.4 \times 10^{-9}$$

 $\lambda = 13.4 \text{ F.I.T. (60\% confidence level @ 25°C)}$

The following failure rate represents data collected from Maxim"s reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maxim-ic.com/qa/reliability/monitor. Cumulative monitor data for the TS50 Process results in a FIT Rate of 0.25 @ 25C and 6.11 @ 55C (0.8 eV, 60% UCL)

B. Moisture Resistance Tests

The industry standard 85°C/85%RH or HAST testing is monitored per device process once a quarter.

C. E.S.D. and Latch-Up Testing

The OX28 die type has been found to have all pins able to withstand a HBM transient pulse of +/-2500 V per Mil-Std 883 Method 3015.7. Latch-Up testing has shown that this device withstands a current of +/-250 mA.



Table 1Reliability Evaluation Test Results

MAX4491AUA+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	
Static Life Test ((Note 1)				
	Ta = 135°C	DC Parameters	80	0	
	Biased	& functionality			
	Time = 192 hrs.				
Moisture Testing	(Note 2)				
HAST	Ta = 130°C	DC Parameters	77	0	
	RH = 85%	& functionality			
	Biased				
	Time = 96hrs.				
Mechanical Stres	ss (Note 2)				
Temperature	-65°C/150°C	DC Parameters	77	0	
Cycle	1000 Cycles	& functionality			
	Method 1010				

Note 1: Life Test Data may represent plastic DIP qualification lots.

Note 2: Generic Package/Process data